SDAS069B - DECEMBER 1982 - REVISED DECEMBER 1994

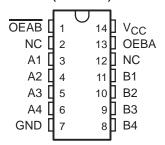
- Two-Way Asynchronous Communication Between Data Buses
- pnp Inputs Reduce dc Loading
- Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

## description

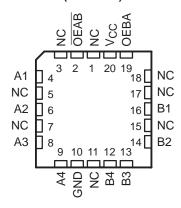
These quadruple bus transceivers are designed for asynchronous two-way communication between data buses. The control-function implementation allows for maximum flexibility in timing. These devices allow data transmission from the A bus to the B bus or from the B bus to the A bus depending upon the logic levels at the output-enable (OEBA and OEAB) inputs. The output-enable inputs can be used to disable the device so that the buses are effectively isolated.

The dual-enable configuration gives the quadruple bus transceivers the capability to store data by simultaneously enabling OEBA and OEAB. Each output reinforces its input in this transceiver configuration. When both control inputs are enabled and all other data sources to the two sets of bus lines are at high impedance, both sets of bus lines (eight in all) retain their states. The 4-bit codes appearing on the two sets of buses are identical.

#### SN54ALS243A . . . J PACKAGE SN74ALS243A . . . D OR N PACKAGE (TOP VIEW)



## SN54ALS243A . . . FK PACKAGE (TOP VIEW)



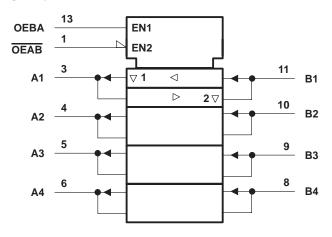
NC - No internal connection

The SN54ALS243A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ALS243A is characterized for operation from 0°C to 70°C.

#### **FUNCTION TABLE**

INP	UTS	
OEAB	OEBA	FUNCTION
L	L	A to B
Н	Н	B to A
Н	L	Isolation
L	Н	Latch A and B (A = B)

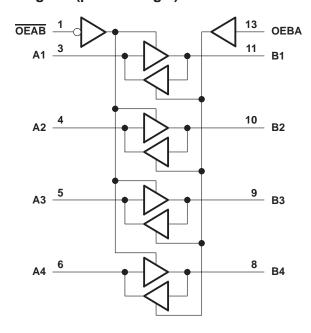
## logic symbol†



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, and N packages.

## logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V <sub>CC</sub>	7 V
Input voltage, V <sub>I</sub> : All inputs	7 V
I/O ports	5.5 V
Operating free-air temperature range, T <sub>A</sub> : SN54ALS243A	–55°C to 125°C
SN74ALS243A	0°C to 70°C
Storage temperature range	–65°C to 150°C

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions

		SN54ALS243A			SN7	LINUT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V <sub>IL</sub>	Low-level input voltage			0.7			0.8	V
IOH	High-level output current			-12			-15	mA
loL	Low-level output current			12			24	mA
TA	Operating free-air temperature	-55		125	0		70	°C

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## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			SN5	4ALS24	3A	SN7				
		TEST CO	TEST CONDITIONS			MAX	MIN	TYP <sup>†</sup>	MAX	UNIT
٧ıĸ		V <sub>CC</sub> = 4.5 V,	I <sub>I</sub> = –18 mA			-1.2			-1.2	V
		V <sub>CC</sub> = 4.5 V to 5.5 V,	$I_{OH} = -0.4 \text{ mA}$	V <sub>CC</sub> -2			V <sub>CC</sub> -2			
			$I_{OH} = -3 \text{ mA}$	2.4	3.2		2.4	3.2		
VOH		V <sub>CC</sub> = 4.5 V	$I_{OH} = -12 \text{ mA}$	2						V
			$I_{OH} = -15 \text{ mA}$				2			
,,		V 45V	I <sub>OL</sub> = 12 mA		0.25	0.4		0.25	0.4	V
VOL		$V_{CC} = 4.5 \text{ V}$	$I_{OL} = 24 \text{ mA}$					0.35	0.5	V
	Control inputs	V 55V	V <sub>I</sub> = 7 V			0.1			0.1	A
l <sub>l</sub>	A or B ports	$V_{CC} = 5.5 \text{ V}$	V <sub>I</sub> = 5.5 V			0.1			0.1	mA
	Control inputs	V 55V	V 07V			20			20	^
lн	A or B ports‡	$V_{CC} = 5.5 \text{ V},$	$V_{I} = 2.7 \text{ V}$		20				20	μΑ
	Control inputs	V 55V				-0.1			-0.1	A
ΊL	A or B ports‡	$V_{CC} = 5.5 \text{ V},$	$V_I = 0.4 V$		-				-0.1	mA
IO§		V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-20		-112	-30		-112	mA
			Outputs high		15	30		15	25	
ICC		V <sub>CC</sub> = 5.5 V	Outputs low		20	35		20	30	mA
			Outputs disabled		21	37		21	32	

## switching characteristics (see Figure 1)

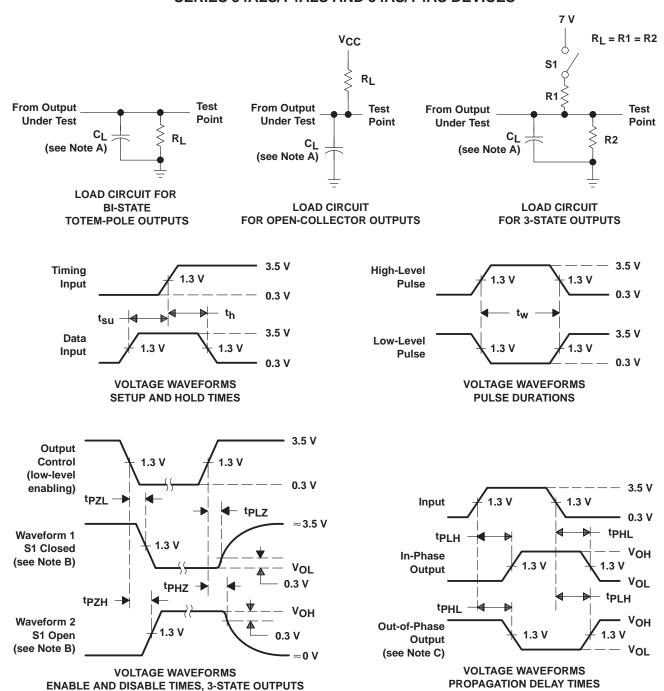
PARAMETER	FROM (INPUT)	TO (OUTPUT)	C <sub>l</sub> R1 R2 T <sub>A</sub>	$\begin{tabular}{llll} $V_{CC} = 4.5 \ V$ to 5.5 \ V$, \\ $C_L = 50 \ pF, \\ $R1 = 500 \ \Omega, \\ $R2 = 500 \ \Omega, \\ $T_A = MIN \ to \ MAX \P$. \\ \hline $SN54ALS243A$ & $SN74ALS243A$ \\ \end{tabular}$				
			MIN	MAX	MIN	MAX		
t <sub>PLH</sub>	A or D	D. c. A	4	15	4	11	ns	
<sup>t</sup> PHL	A or B	B or A	4	15	4	11		
<sup>t</sup> PZH	OEAB	<b>D</b>	7	25	7	20	ns	
t <sub>PZL</sub>	OEAB	В	7	25	7	20		
<sup>t</sup> PHZ	<del></del> OEAB	<b>D</b>	2	16	2	14		
t <sub>PLZ</sub>	OEAB	В	3	27	3	22	ns	
<sup>t</sup> PZH	OED4		7	25	7	20		
tPZL	OEBA	Α	7	25	7	20	ns	
<sup>t</sup> PHZ	OEBA	A	2	16	2	14	20	
t <sub>PLZ</sub>	OLDA	^	3	27	3	22	ns	

<sup>¶</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>†</sup> All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C. ‡ For I/O ports, the parameters  $I_{IH}$  and  $I_{IL}$  include the off-state output current.

<sup>§</sup> The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

# PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
  - D. All input pulses have the following characteristics: PRR  $\leq$  1 MHz,  $t_f = t_f = 2$  ns, duty cycle = 50%.
  - E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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#### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
84013022A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	84013022A SNJ54ALS 243AFK	Samples
SNJ54ALS243AFK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	84013022A SNJ54ALS 243AFK	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## **PACKAGE OPTION ADDENDUM**

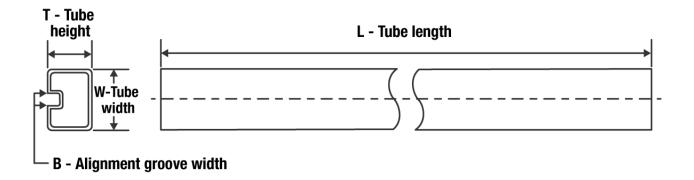
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## PACKAGE MATERIALS INFORMATION

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## **TUBE**



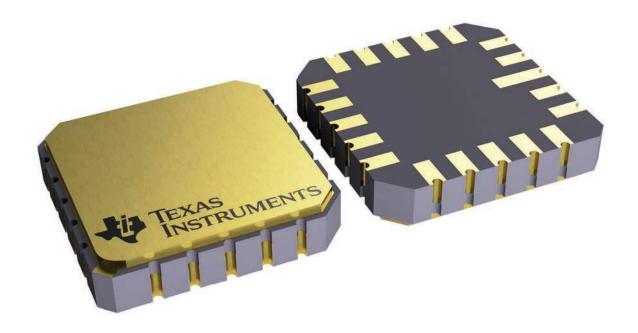
#### \*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
84013022A	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ54ALS243AFK	FK	LCCC	20	1	506.98	12.06	2030	NA

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



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